

Microsemi Corporation

May 1, 2016

Product Discontinuance Notification (PDN) No: PDN-001

Subject: UXN6M9P

Description:

Microsemi Discrete Products Group – RFMW is announcing the discontinuance of the UXN6M9P Prescalar due to the obsolescence of the underlying wafer process.

Reason for Discontinuance:

The foundry Microsemi used to produce this part has obsoleted the process.

Customer Impact:

A limited number of UXN6M9P parts will be available for a transition to alternative solutions. Microsemi will allocate these parts to address customer migrations.

Replacement Parts:

Microsemi at this time does not have an exact replacement part. We are evaluating an alternative bonding arrangement for the UXN14M9P and will have samples available in 30 -45 days.

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Microsemi parts UXN14M9P and UXN14M32K are available. They provide similar functionality, although with a different Pinout arrangement.

Products Affected by this Discontinuance: UXN6M9P

Contact Information:

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Regards,

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Any projected dates in this notification are based on the most current product information at the time this PDN is being issued, but they may change due to unforeseen circumstances. For the latest schedule and any other information, please contact your local Microsemi Sales Office, the factory contact shown above, or your local distributor.

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